UNIKC Semiconductor

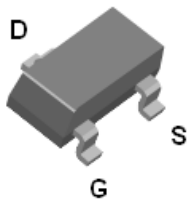
RoHS Compliant

PK615BMA

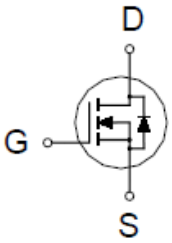
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
150V	2.6Ω @V_{GS} = 10V	0.45A



SOT-23(S)



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_A = 25 °C	I_D	0.45	A
	T_A = 70 °C		0.3	
Pulsed Drain Current[1]		I_{DM}	2.2	
Power Dissipation	T_A = 25 °C	P_D	0.9	W
	T_A = 70 °C		0.6	
Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$		130	°C / W

[1] limited by maximum junction temperature.

UNIKC Semiconductor

RoHS Compliant

PK615BMA

N-Channel Enhancement Mode MOSFET

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	150			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1	2	3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 120V, V_{GS} = 0V			1	μA
		V_{DS} = 100V, V_{GS} = 0V , T_J = 70 °C			10	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 5V, V_{GS} = 10V	2.2			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 0.3A		1.4	2.6	Ω
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 0.3A		1		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		110		pF
Output Capacitance	C_{oss}			11		
Reverse Transfer Capacitance	C_{rss}			8		
Total Gate Charge[2]	Q_g	V_{DS} = 0.5$V_{(BR)DSS}$, V_{GS} = 10V, I_D = 0.3A		4.4		nC
Gate-Source Charge[2]	Q_{gs}			0.5		
Gate-Drain Charge[2]	Q_{gd}			2.9		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DS} = 75V $I_D \cong$ 0.3A, V_{GS} = 10V, R_{GEN} = 6Ω		14		nS
Rise Time[2]	t_r			12.6		
Turn-Off Delay Time[2]	$t_{d(off)}$			104		
Fall Time[2]	t_f			52		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICE (T_J = 25 °C)						
Continuous Current	I_S				0.45	A
Forward Voltage[1]	V_{SD}	I_F = 1.3A, V_{GS} = 0V			1.5	V
Reverse Recovery Time	t_{rr}	I_F = 2A, dI_F/dt=100A/μS		41		nS
Reverse Recovery Charge	Q_{rr}			32		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.

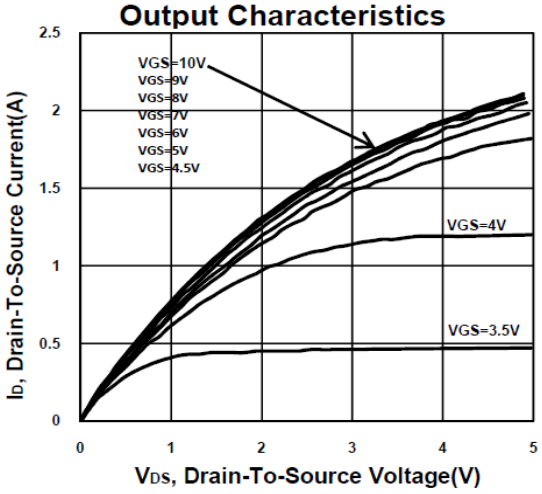
UNIKC Semiconductor

RoHS Compliant

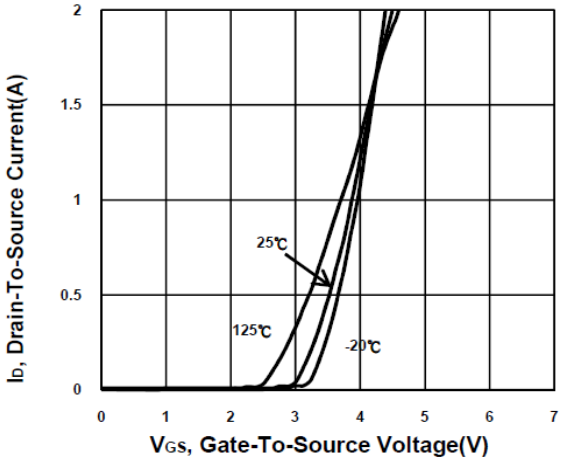
PK615BMA

N-Channel Enhancement Mode MOSFET

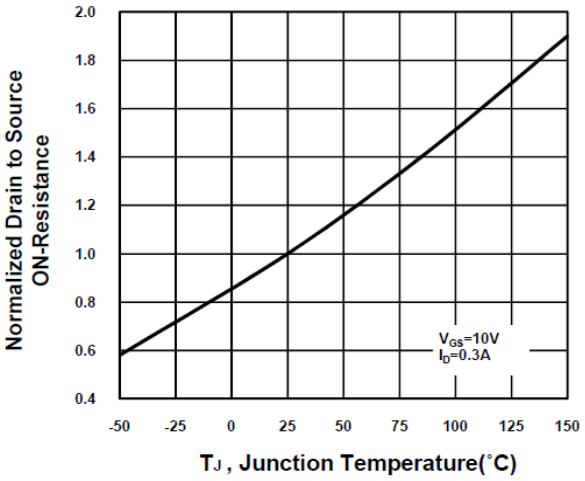
Output Characteristics



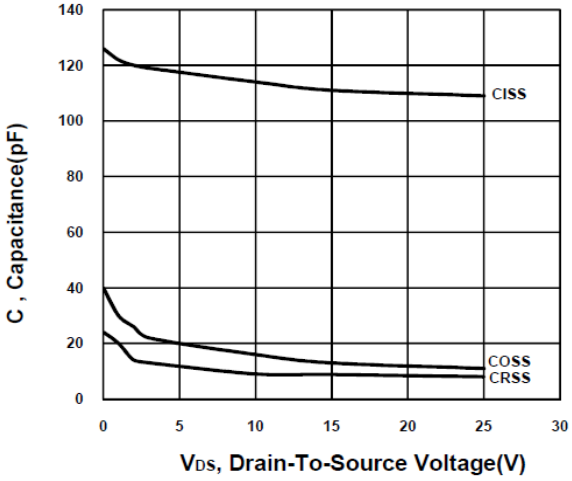
Transfer Characteristics



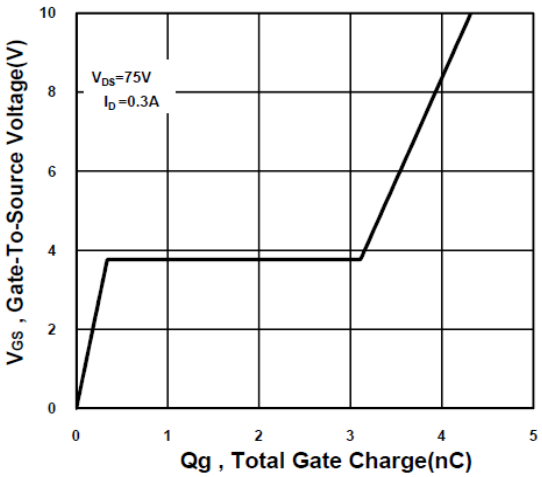
On-Resistance VS Temperature



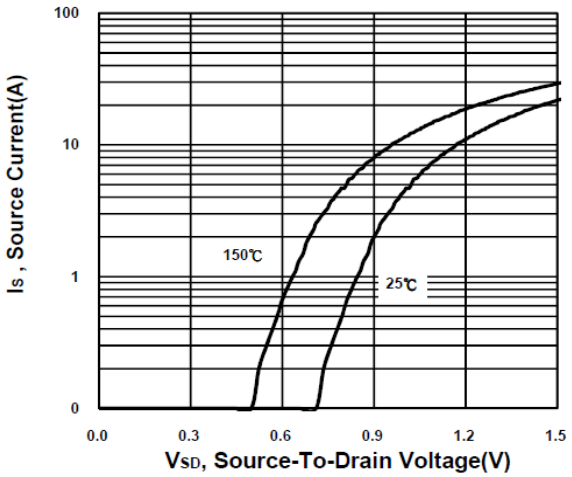
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage



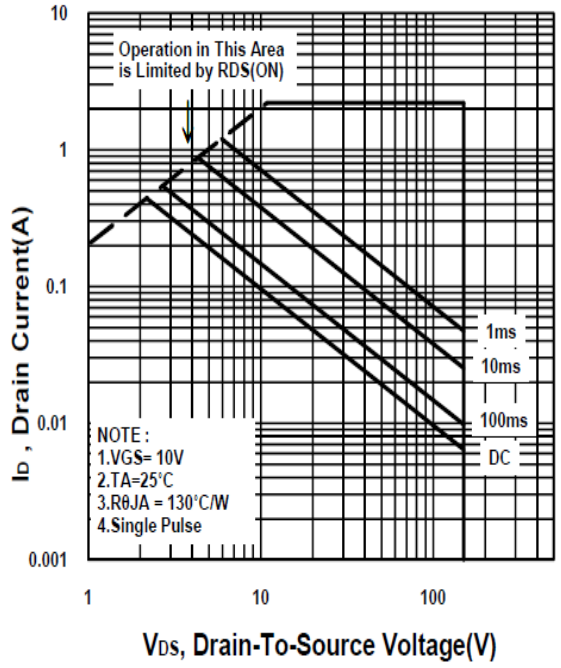
UNIKC Semiconductor

RoHS Compliant

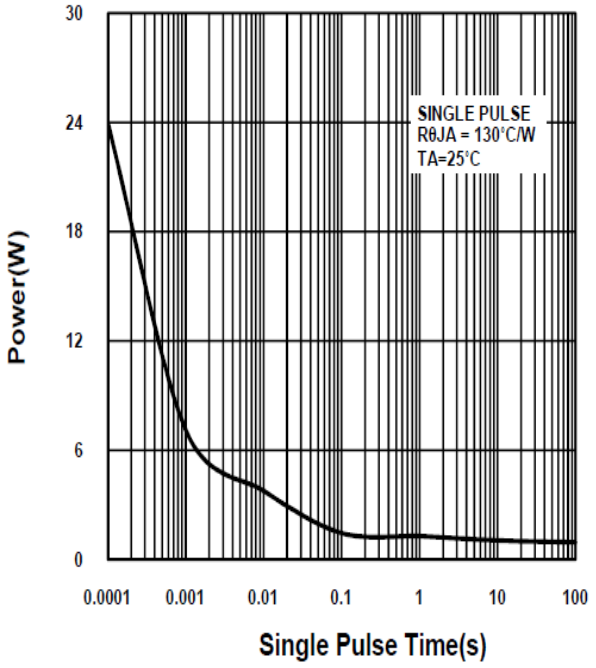
PK615BMA

N-Channel Enhancement Mode MOSFET

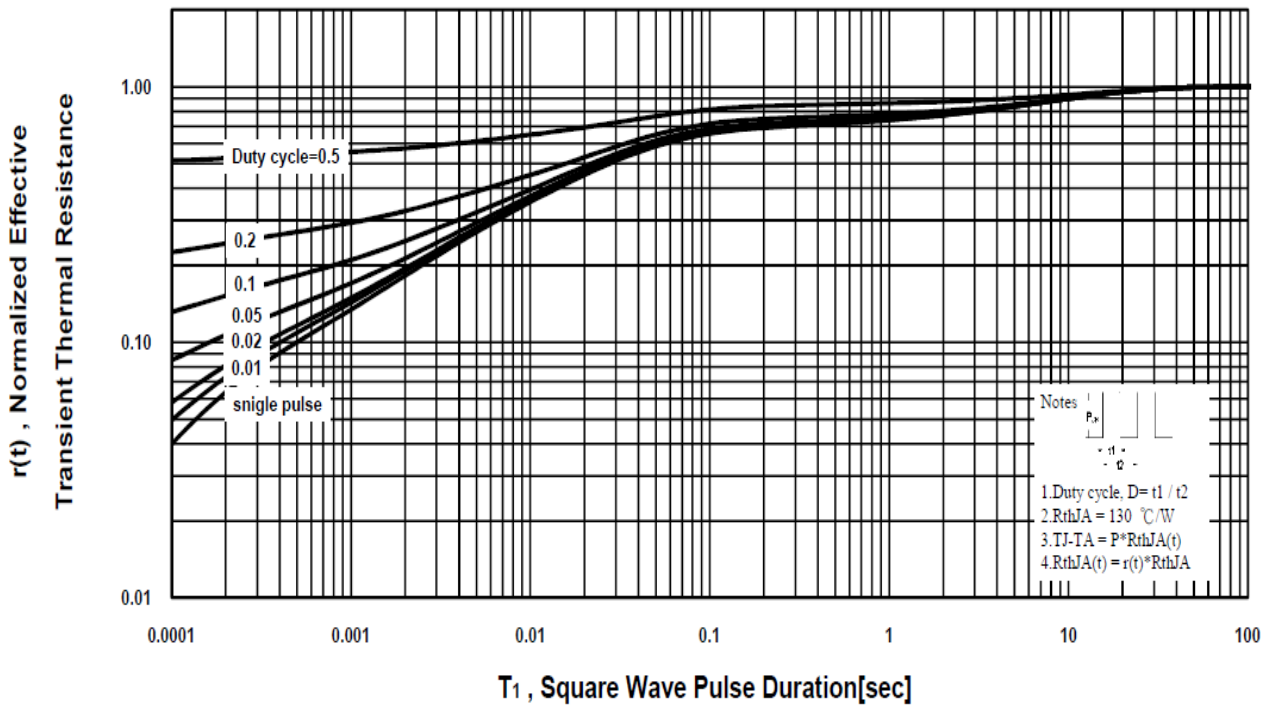
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



UNIKC Semiconductor

RoHS Compliant

PK615BMA

N-Channel Enhancement Mode MOSFET

Package Dimension

SOT-23 (S) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	0.9		1	H	0.08		0.2
B	2.25		2.85	I	0.15		0.6
C	1.2		1.4				
D	2.8		3.04				
E	0.89		1.2				
F	0		0.1				
G	0.3		0.5